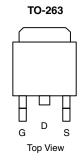


Vishay Siliconix

N-Channel 60 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ)			
60	0.0044 at V _{GS} = 10 V	90 ^d	105			



Ordering Information: SUM90N06-4m4P-E3 (Lead (Pb)-free)

FEATURES

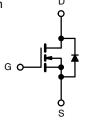
- TrenchFET® Power MOSFET
- 175 °C Junction Temperatur



- 100 % R_q and UIS Tested
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Power Supply
 - Secondary Synchronous Rectification
- Industrial
- **OR-ing**



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
Parameter	Symbol	Limit	Unit			
Drain-Source Voltage	V _{DS}	60	V			
Gate-Source Voltage	V _{GS}	± 20	v			
Continuous Drain Current (T _{.I} = 175 °C)	T _C = 25 °C	I-	90 ^d	Α		
Continuous Diain Current (1) = 175 C)	T _C = 70 °C	I _D	90 ^d			
Pulsed Drain Current	I _{DM}	240] ^			
Avalanche Current	I _{AS}	70				
Single Avalanche Energy ^a	L = 0.1 mH	E _{AS}	245	mJ		
Mariana Barra Biaria di ad	T _C = 25 °C	В	300 ^b	10/		
Maximum Power Dissipation ^a	T _A = 25 °C ^c	P _D	3.75	W		
Operating Junction and Storage Temperature R	T _J , T _{stg}	- 55 to 175	°C			

THERMAL RESISTANCE RATINGS						
Parameter	Symbol	Limit	Unit			
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	40	°C/W			
Junction-to-Case (Drain)	R _{thJC}	0.5	C/ VV			

- a. Duty cycle \leq 1 %.
- b. See SOA curve for voltage derating.
- c. When mounted on 1" square PCB (FR-4 material).
- d. Package limited.

SUM90N06-4m4P

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SPECIFICATIONS (T _C = 25			N/II-	Typ	Mass	I I m 'A	
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static		V 0.V I 050 v A	60	1			
Drain-Source Breakdown Voltage	V _{DS}	-				V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.5		4.5		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 250	nA	
		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$			1	μΑ	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$			50		
		V _{DS} = 60 V, V _{GS} = 0 V, T _J = 150 °C			250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	70			Α	
David Course Co Chala Davida	B	$V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$		0.0036	0.0044	0	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}, T_J = 125 ^{\circ}\text{C}$		0.0059	0.0077	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 20 A		60		S	
Dynamic ^b							
Input Capacitance	C _{iss}			6190		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = 30 \text{ V}, f = 1 \text{ MHz}$		990			
Reverse Transfer Capacitance	C _{rss}			340			
Total Gate Charge ^c	Q_{g}			105	160	nC	
Gate-Source Charge ^c	Q_{gs}	$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 85 \text{ A}$		29			
Gate-Drain Charge ^c	Q_{gd}			28			
Gate Resistance	R_{g}	f = 1 MHz		1.4	2.8	Ω	
Turn-On Delay Time ^c	t _{d(on)}			23	35		
Rise Time ^c	t _r	V_{DD} = 30 V, R_L = 0.4 Ω		15	25	ns	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D\cong 85$ A, $V_{GEN}=10$ V, $R_g=1$ Ω		36	55		
Fall Time ^c	t _f			8	15		
Source-Drain Diode Ratings and Cha	aracteristics (T _C = 25 °C) ^b					
Continuous Current	I _S				85		
Pulsed Current	I _{SM}				240	Α	
Forward Voltage ^a	V _{SD}	I _F = 30 A, V _{GS} = 0 V		0.84	1.5	V	
Reverse Recovery Time	t _{rr}			61	100	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 75 A, di/dt = 100 A/μs		3.0	4.5	Α	
Reverse Recovery Charge Q _{rr}				91	140	μС	

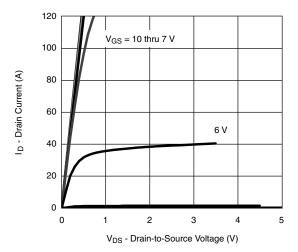
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

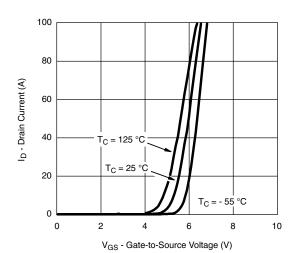
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



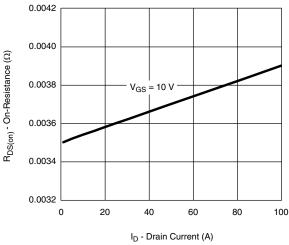
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



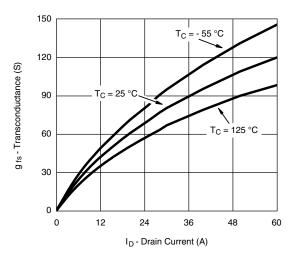
Output Characteristics



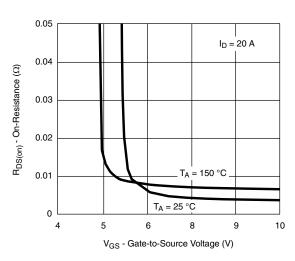
Transfer Characteristics



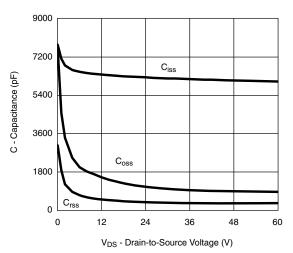
On-Resistance vs. Drain Current



Transconductance



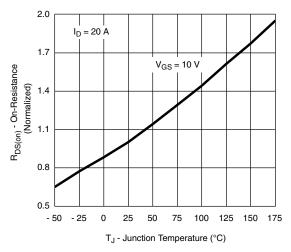
On-Resistance vs. Gate-to-Source Voltage



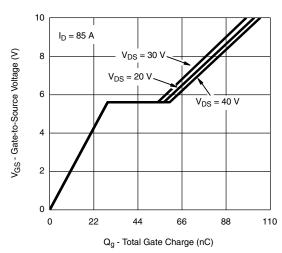
Capacitance

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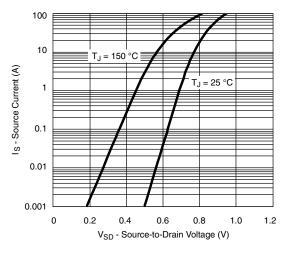
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



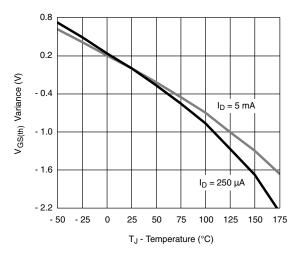
On-Resistance vs. Junction Temperature



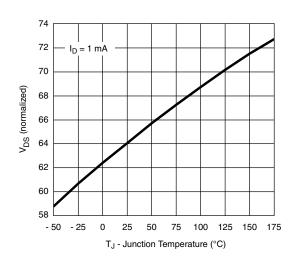
Gate Charge



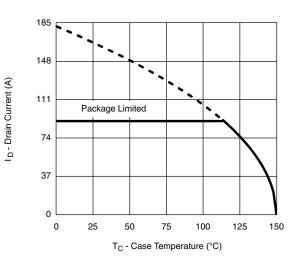
Source-Drain Diode Forward Voltage



Threshold Voltage



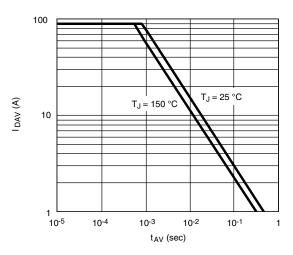
On-Resistance vs. Junction Temperature

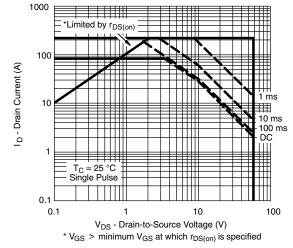


Maximum Drain Current vs. Case Temperature

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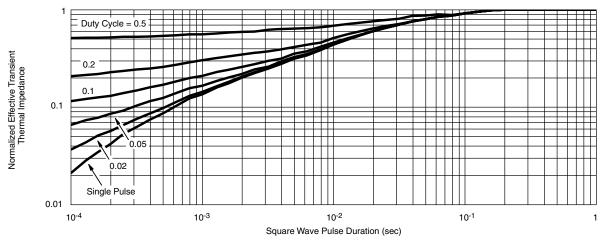
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





Single Pulse Avalanche Current Capability vs. Time



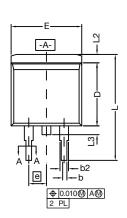


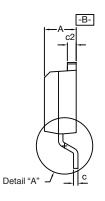
Normalized Thermal Transient Impedance, Junction-to-Case

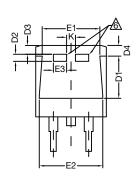
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TO-263 (D²PAK): 3-LEAD









DETAIL A (ROTATED 90°)



_	,	—b - -b	 1			1
2	T			C	_ (<u>-</u>
	SE	^TIC	M	ا م		1

- 1. Plane B includes maximum features of heat sink tab and plastic.
- 2. No more than 25 % of L1 can fall above seating plane by max. 8 mils.
- 3. Pin-to-pin coplanarity max. 4 mils.
- 4. *: Thin lead is for SUB, SYB. Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

6 This feature is for thick lead.

		INCHES		MILLIMETERS		
	DIM.	MIN.	MAX.	MIN.	MAX.	
Α		0.160	0.190	4.064	4.826	
	b	0.020	0.039	0.508	0.990	
	b1	0.020	0.035	0.508	0.889	
	b2	0.045	0.055	1.143	1.397	
c*	Thin lead	0.013	0.018	0.330	0.457	
	Thick lead	0.023	0.028	0.584	0.711	
c1	Thin lead	0.013	0.017	0.330	0.431	
CI	Thick lead	0.023	0.027	0.584	0.685	
	c2	0.045	0.055	1.143	1.397	
	D	0.340	0.380	8.636	9.652	
	D1	0.220	0.240	5.588	6.096	
	D2	0.038	0.042	0.965	1.067	
	D3	0.045	0.055	1.143	1.397	
	D4	0.044	0.052	1.118	1.321	
	Е	0.380	0.410	9.652	10.414	
	E1	0.245	-	6.223	-	
	E2	0.355	0.375	9.017	9.525	
	E3	0.072	0.078	1.829	1.981	
	е	0.100	BSC	2.54 BSC		
	K	0.045	0.055	1.143	1.397	
	L	0.575	0.625	14.605	15.875	
	L1	0.090	0.110	2.286	2.794	
	L2	0.040	0.055	1.016	1.397	
L3		0.050	0.070	1.270	1.778	
	L4	0.010 BSC		0.254 BSC		
М		-	0.002	-	0.050	
ECN: T13-0707-Rev. K, 30-Sep-13						

DWG: 5843





RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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Revision: 02-Oct-12 Document Number: 91000